

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L8	54	((back adj (surface or side)) same (CMP or polish\$6 or grind\$6 or ground)) same (ozone or O3 or "O.sub.3")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/23 13:17
L9	50	8 and (@ad<"20040325" or @rlad<"20040325")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/23 13:17
L10	38	9 and semiconductor	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/23 13:17

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L1	23	(deactivat\$6 or (de adj activat\$6)) with (semiconductor or wafer or substrate) with (polish\$6 or grind\$6 or CMP)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/23 12:43
L2	15	1 and (@ad<"20030529" or @rlad<"20030529")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/23 12:45

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L14	21	(dic\$6 near5 (pad or sheet)) with ((stick\$6 or adhes\$6) adj force) with (reduc\$6 or decreas\$6 or lower\$6)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/23 17:21
L15	18	14 and (@ad<"20040325" or @rlad<"20040325")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/23 17:21
L16	18	15 and semiconductor	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/23 17:21
L17	17	16 and (deactivat\$6 or (de adj activat\$6) or treat\$6 or posttreat\$6 or pretreat\$6 or ozone or "O.sub.3" or O3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/23 17:22